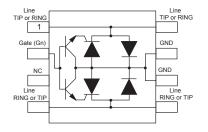


Programmable transient voltage suppressor for SLIC protection





Product status link

Features

- Programmable transient suppressor
- · Wide negative firing voltage range:
 - V_{Gn} = -175 V max.
- Low dynamic switching voltages:
 - V_{FP} and V_{DGL}
- Low gate triggering current: I_{GT} = 5 mA max.
- Peak pulse current: I_{PP} = 40 A (5/310 μs)
- Holding current: I_H = 150 mA min.
- Benefits:
 - A Trisil is not subject to ageing and provides a fail-safe mode in short circuit for a better protection.
 - Trisils are used to help equipment to meet various standards such as UL60950, IEC 60950 / CSA C22.2, UL1459 and TIA-968-A (formerly FCC part 68)
 - Trisils have UL94 V0 resin approved (Trisils are UL497B approved file: E136224)

Description

These devices have been especially designed to protect new high voltage, as well as classical SLICs, against transient overvoltages.

Positive overvoltages are clamped by 2 diodes. Negative surges are suppressed by 2 thyristors, their breakdown voltage being referenced to -V_{BAT} through the gate.

These components present a very low gate triggering current (IGT) in order to reduce the current consumption on printed circuit board during the firing phase.



1 Characteristics

Table 1. Standards compliance

Standard	Peak surge voltage (V)	Voltage waveform	Required peak current (A)	Current waveform	Minimum serial resistor to meet standard (Ω)
GR-1089 core first level	2500	2/10 μs	500	2/10 μs	12
GR-1009 COTE HIST level	1000	10/1000 µs	100	10/1000 µs	24
GR-1089 core second level	5000	2/10 µs	500	2/10 µs	24
GR-1089 core intra- building	1500	2/10 µs	100	2/10 µs	0
ITU-T-K20/K21	6000	10/700 µs	150	5/310 µs	110
110-1-R20/R21	1500	10/700 μs	37.5	5/3 10 μs	0
ITU-T-K20 (IEC	8000	1/60 ns	ESD conta	0	
61000-4-2)	15000	1700 115	ESD air	0	
IEC 61000-4-5	4000	10/700 µs	100	5/310 μs	60
IEC 01000-4-5	4000	1.2/50 µs	100	8/20 µs	0
TIA-968-A,	1500	10/160 µs	200	10/160 µs	22.5
lightning surge	800	10/160 µs	100	10/160 µs	15
type A	000	10/300 μ3	100	10/300 μ8	13
TIA-968-A,					
lightning surge	1000	9/720 μs	25	5/320 μs	0
type B					

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient	120	°C/W

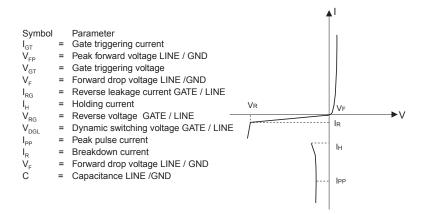
DS6608 - Rev 8 page 2/13

Table 3. Absolute ratings ($T_{amb} = 25$ °C)

Symbol		Parameter		Value	Unit
		Telcordia GR-1089-CORE Issue 6, May2011, section 4	10/1000 μs	30	
		TIA-968-A, lightning surge type A	10/560 μs	35	
		ITU-T K20/21/44/45, (10/700 μs open circuit voltage waveshape)	5/310 µs	40	
		TIA-968-A, lightning surge type A	10/160 µs	50	
I _{pp}	Peak pulse current(1)	IEC 61000-4-5, (1.2/50 μ s open circuit waveshape) with 10 Ω	4/30 µs	110	Α
		ITU-T K20/21/44/45,			
		(1.2/50 μs open circuit voltage waveshape)	8/20 µs	120	
		Telcordia			
		GR-1089-CORE Issue 6,	2/10 µs	150	
		(2/10 µs open circuit waveshape)			
			t = 20 ms	18	
I_{TSM}	Non repetitive surge peak on-state current (50 Hz sinusoidal) t = 200 ms			10	Α
	t = 1 s		t = 1 s	7	
V_{Gn}	Negative battery volta	-40 °C < T _{amb} < +85 °C	-175	V	
T _{stg}	Storage junction temp	FF 1- 1 450	°C		
Tj	Maximum operating junction temperature range				
T _L	Maximum temperature for soldering during 10 s				

^{1.} The rated current values may be applied either to the Ring to GND or to the Tip to GND terminal pairs. Additionally, the four terminal pairs may have their rated current values applied simultaneously (in this case the GND terminal current will be four times the rated current value of an individual terminal pair). Both GND pins must be connected to GND.

Figure 1. Electrical characteristics (definitions)



DS6608 - Rev 8 page 3/13

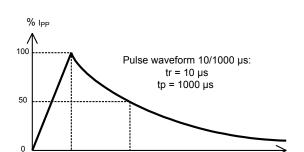


Figure 2. Pulse waveform

Table 4. Parameters (T_j = 25 °C, unless otherwise specified)

Symbol		Parameter							Unit
I _{GT}	V _{LINE} = -48 V	V _{LINE} = -48 V						5	mA
I _H	V _{Gn} = -48 V					150			mA
V_{GT}	at I _{GT}							2.5	V
	V _{RG} = -175 V				T _j = 25 °C			5	
I _{RG}	V _{RG} = -175 V	V _{RG} = -175 V			T _j = 85 °C			50	μA
		10/700 μs	1.5 kV	R _S = 10 Ω	I _{PP} = 30 A			7	
$V_{DGL}^{(1)}$	V _{Gn} = -48 V	1.2/50 µs	1.5 kV	R _S = 10 Ω	I _{PP} = 30 A			10	V
		2/10 μs	2.5 kV	R _S = 62 Ω	I _{PP} = 38 A			25	
V _F	I _F = 5 A			t = 500 μs				3	V
	10/700 µs			1.5 kV	R _S = 10 Ω			5	
V_{FP}	1.2/50 µs			1.5 kV	R _S = 10 Ω			9	V
	2/10 μs			2.5 kV	R _S = 62 Ω			30	
	V _{Gn / LINE} = -1 V, V _{LINE} = -175 V				T _j = 25 °C			5	
I _R	V _{Gn / LINE} = -1 V, V		T _j = 85 °C			50	μA		
	V _{LINE} = -50 V, V _{RMS} = 1 V, f = 1 MHz						15		
С	V _{LINE} = -2 V, V _{RMS} = 1 V, f = 1 MHz				35		pF		

^{1.} The oscillations with a time duration lower than 50 ns are not taken into account.

Table 5. Recommended gate capacitance

Symbol	Parameter	Min.	Тур.	Max.	Unit
C_{G}	Gate decoupling capacitance	100	220		nF

DS6608 - Rev 8 page 4/13



2 Technical information

Rs1
L1 O

RS1

IG

TIP

VTip

VTip

GND

Rs2

RING

VRing

Figure 3. LCP concept behavior

Figure 3 shows the classical protection circuit using the LCP crowbar concept. This topology has been developed to protect the new high voltage SLICs. It allows to program the negative firing threshold while the positive clamping value is fixed at GND.

When a negative surge occurs on one wire (L1 for example) a current IG flows through the base of the transistor T1 and then injects a current in the gate of the thyristor Th1. Th1 fires and all the surge current flows through the ground. After the surge when the current flowing through Th1 becomes less negative than the holding current IH, then Th1 switches off.

When a positive surge occurs on one wire (L1 for example) the diode D1 conducts and the surge current flows through the ground.

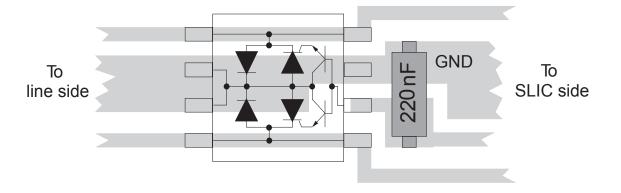


Figure 4. Example of PCB layout based on LCP1521S protection

Figure 4 shows the classical PCB layout used to optimize line protection.

The capacitor C is used to speed up the crowbar structure firing during the fast surge edges.

This allows minimization of the dynamic breakover voltage at the SLIC Tip and Ring inputs during fast strikes. Note that this capacitor is generally present around the SLIC - V_{bat} pin.

So to be efficient it has to be as close as possible from the LCP Gate pin and from the reference ground track (or plan) (see Figure 4). The optimized value for C is 220 nF.

DS6608 - Rev 8 page 5/13



The series resistors Rs1 and Rs2 designed in Figure 3 represent the fuse resistors or the PTC which are mandatory to withstand the power contact or the power induction tests imposed by the various country standards. Taking into account this fact the actual lightning surge current flowing through the LCP is equal to:

- surge = $V_{surge} / (R_g + R_s)$ with:
 - V surge = peak surge voltage imposed by the standard
 - R_q = series resistor of the surge generator
 - R_s = series resistor of the line card (e.g. PTC)

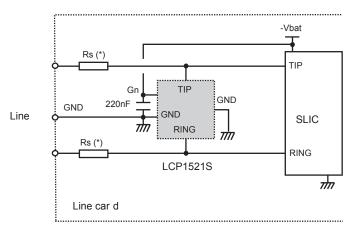
E.g. For a line card with 30 Ω of series resistors which has to be qualified under GR1089 core 1000V 10/1000 μ s surge, the actual current through the LCP is equal to:

• I_{surge} = 1000 / (10 + 30) = 25 A

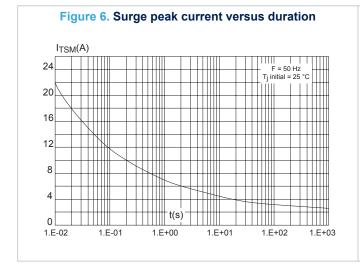
The LCP is particularly optimized for the new telecom applications such as the fiber in the loop, the WLL, the remote central office. In this case, the operating voltages are smaller than in the classical system. This makes the high voltage SLICs particularly suitable.

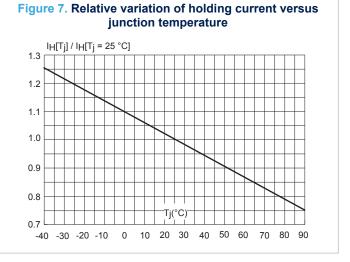
The schematics of Figure 5 give the most frequent topology used for these applications.

Figure 5. Protection of high voltage SLIC



Rs (*) = PTC or fuse resistor





DS6608 - Rev 8 page 6/13



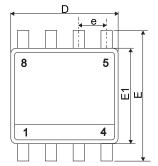
Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 8. SO-8 package outline

SO-8 package information 3.1

□ ccc C



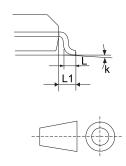


Table 6. SO-8 package mechanical data

	Dimensions						
Ref.		Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.75			0.069	
A1	0.1		0.25	0.004		0.010	
A2	1.25			0.049			
b	0.31		0.51	0.012		0.020	
С	0.10		0.25	0.004		0.010	
D	4.80	4.90	5.00	0.189	0.193	0.197	
E	5.80	6.00	6.20	0.228	0.236	0.244	
E1	3.80	3.90	4.00	0.150	0.154	0.157	
е		1.27			0.050		
h	0.25		0.50	0.010		0.020	
L	0.40		1.27	0.016		0.05	
L1		1.04			0.041		
k°	0		8	0		8	
ccc			0.10			0.004	

DS6608 - Rev 8 page 7/13



Figure 9. Footprint recommendations, dimensions in mm (inches)

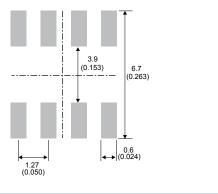


Figure 10. Marking layout (refer to ordering information table for marking)

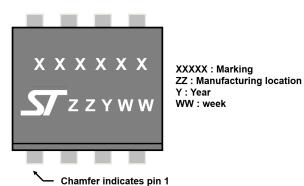
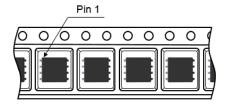


Figure 11. Package orientation in reel



Taped according to EIA-481

Note: Pocket dimensions are not on scale

Pocket shape may vary depending on package

Figure 12. Tape and reel orientation

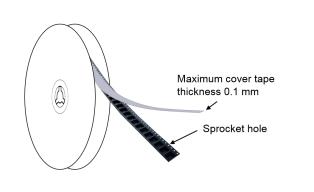


Figure 13. Reel dimensions (mm)

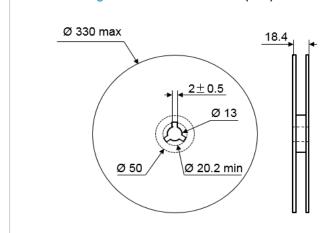
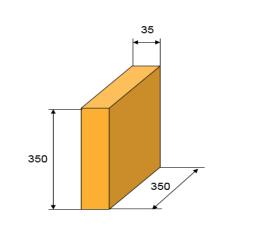


Figure 14. Inner box dimensions (mm)



DS6608 - Rev 8 page 8/13



Figure 15. Tape and reel outline

Note: Pocket dimensions are not on scale Pocket shape may vary depending on package

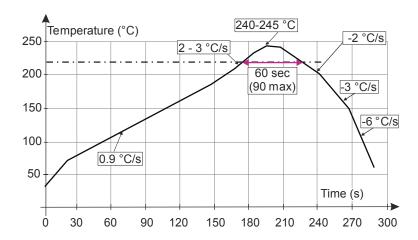
Table 7. Tape and reel mechanical data

	Dimensions						
Ref.	Millimeters						
	Min.	Тур.	Max.				
P0	3.9	4	4.1				
P1	7.9	8	8.1				
P2	1.95	2	2.05				
ØD0	1.45	1.5	1.6				
ØD1	1.6						
F	5.45	5.5	5.55				
K0	2.5	2.6	2.7				
W	11.7	12	12.3				

DS6608 - Rev 8 page 9/13



Figure 16. ST ECOPACK recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

DS6608 - Rev 8 page 10/13





4 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
LCP1521SRL	CP152S	SO-8	0.08 g	2500	Tape and reel

DS6608 - Rev 8 page 11/13



Revision history

Table 9. Document revision history

Date	Revision	Changes
20-Nov-2009	1	First issue.
23-Feb-2012	2	Standardized nomenclature for Gn.
15-Nov-2013	3	Updated Figure 9.
10-Apr-2015	4	Updated Figure 1, Figure 10 and package view. Added Figure 11. Updated Table 3 and Table 7.
02-Jul-2015	5	Updated package information.
08-Jul-2015	6	Updated Figure 9.
12-Dec-2017	7	Updated Table 3: "Absolute ratings (Tj = 25 °C, unless otherwise specified)" and Section 3: "Package information".
25-Jul-2019	8	Updated Figure 10.

DS6608 - Rev 8 page 12/13



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2019 STMicroelectronics - All rights reserved

DS6608 - Rev 8 page 13/13